GENERAL DESCRIPTION

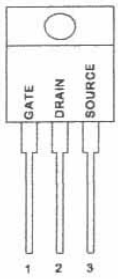
This high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition, this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes. The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power supplies, converters and PWM motor controls, these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

FEATURES

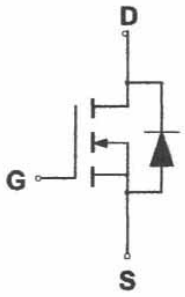
- Robust High Voltage Termination
- Avalanche Energy Specified
- Source-to-Drain Diode Recovery Time Comparable to a Discrete Fast Recovery Diode
- Diode is Characterized for Use in Bridge Circuits
- I_{DSS} Specified at Elevated Temperature

PIN CONFIGURATION

TO-220FP
Front View



SYMBOL



N-Channel MOSFET

ABSOLUTE MAXIMUM RATIGS

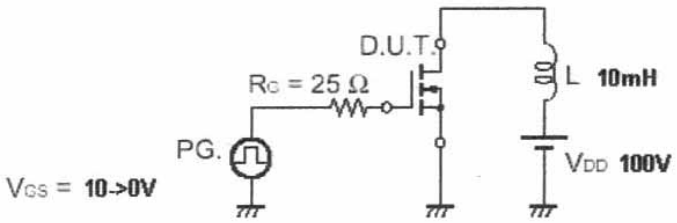
Rating	Symbol	Value	Unit
Drain to Current — Continuous	I_D	6.0	A
— Pulsed	I_{DM}	18	
Gate-to-Source Voltage — Continue	V_{GS}	±20	V
— Non-repetitive	V_{GSM}	±40	V
Total Power Dissipation	P_D		W
TO-220		125	
TO-220FP		45	
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to 150	℃
Single Pulse Drain-to-Source Avalanche Energy — T_J = 25℃ (V_{DD} = 100V, V_{GS} = 10V, I_L = 6A, L = 10mH, R_G = 25Ω)	E_{AS}	180	mJ
Thermal Resistance — Junction to Case	θ_{JC}	1.0	℃/W
— Junction to Ambient	θ_{JA}	62.5	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	T_L	260	℃

(1) VDD = 50V, ID = 6A
(2) Pulse Width and frequency is limited by $T_{J(max)}$ and thermal response

ORDERING INFORMATION

Part Number	Package
2SK3130	TO-220FP

TEST CIRCUIT



Test Circuit – Avalanche Capability

ELECTRICAL CHARACTERISTICS

Unless otherwise specified, T_J=25°C.

Characteristic		Symbol	2SK3130 Min	Typ	Max	Units
Drain-Source Breakdown Voltage (V_{GS} = 0 V, I_D = 250 μA)		$V_{(BR)DSS}$	600			V
Drain-Source Leakage Current (V_{DS} = 600 V, V_{GS} = 0 V)		I_{DSS}			100	μA
(V_{DS} = 480 V, V_{GS} = 0 V, T_J = 125℃)					50	
Gate-Source Leakage Current-Forward (V_{gsf} = 20 V, V_{DS} = 0 V)		I_{GSSF}			100	nA
Gate-Source Leakage Current-Reverse (V_{gsr} = 20 V, V_{DS} = 0 V)		I_{GSSR}			100	nA
Gate Threshold Voltage (V_{DS} = V_{GS}, I_D = 250 μA)		$V_{GS(th)}$	2.0		4.0	V
Static Drain-Source On-Resistance (V_{GS} = 10 V, I_D = 3.5A) *		$R_{DS(on)}$			1.12	Ω
Forward Transconductance (V_{DS} = 15 V, I_D = 3.0A) *		g_{FS}	3.4			mhos
Input Capacitance	(V_{DS} = 25 V, V_{GS} = 0 V, f = 1.0 MHz)	C_{iss}		1498	2100	pF
Output Capacitance		C_{oss}		158	220	pF
Reverse Transfer Capacitance		C_{rss}		29	60	pF
Turn-On Delay Time	(V_{DD} = 300 V, I_D = 6.0 A, V_{GS} = 10 V, R_G = 9.1Ω) *	$t_{d(on)}$		14	30	ns
Rise Time		t_r		19	40	ns
Turn-Off Delay Time		$t_{d(off)}$		40	80	ns
Fall Time		t_f		26	55	ns
Total Gate Charge	(V_{DS} = 300 V, I_D = 6.0 A, V_{GS} = 10 V)*	Q_g		35.5	50	nC
Gate-Source Charge		Q_{gs}		8.1		nC
Gate-Drain Charge		Q_{gd}		14.1		nC
Internal Drain Inductance (Measured from the drain lead 0.25" from package to center of die)		L_D		4.5		nH
Internal Drain Inductance (Measured from the source lead 0.25" from package to source bond pad)		L_S		7.5		nH
SOURCE-DRAIN DIODE CHARACTERISTICS						
Forward On-Voltage(1)	(I_S = 6.0 A, dI_S/dt = 100A/μs)	V_{SD}		0.83	1.2	V
Forward Turn-On Time		t_{on}		**		ns
Reverse Recovery Time		t_{rr}		266		ns

* Pulse Test: Pulse Width ≤300μs, Duty Cycle ≤2%

** Negligible, Dominated by circuit inductance

TYPICAL ELECTRICAL CHARACTERISTICS

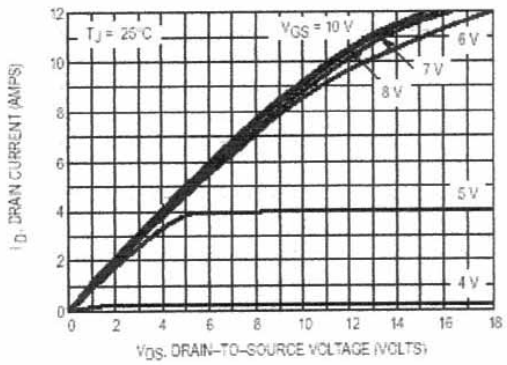


Figure 1. On–Region Characteristics

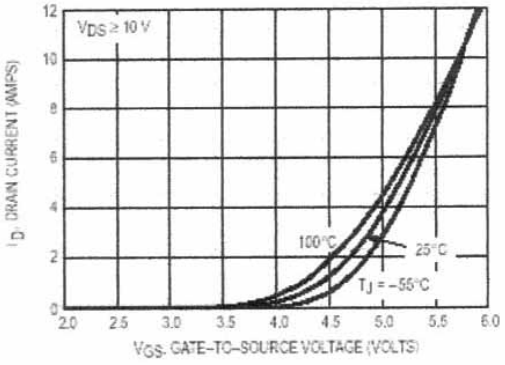


Figure 2. Transfer Characteristics

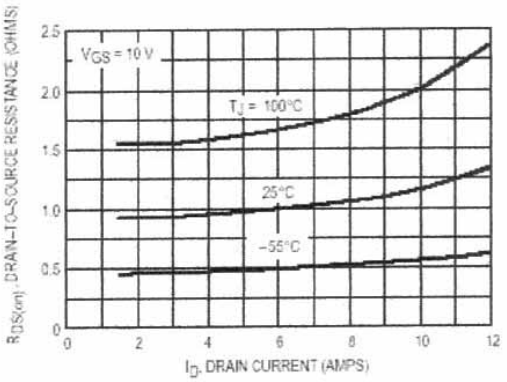


Figure 3. On–Resistance versus Drain Current and Temperature

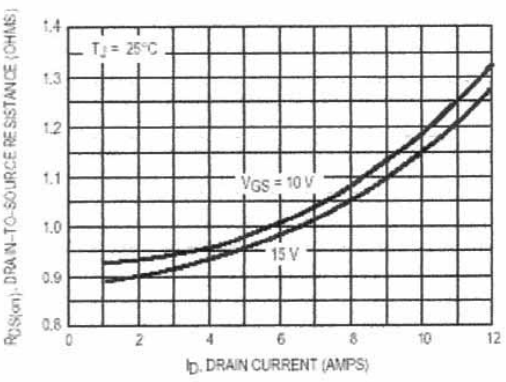


Figure 4. On–Resistance versus Drain Current and Gate Voltage

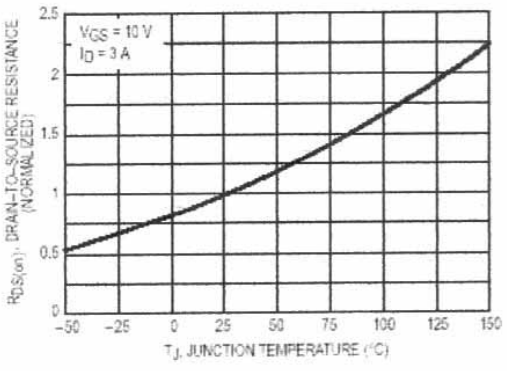


Figure 5. On–Resistance Variation with Temperature

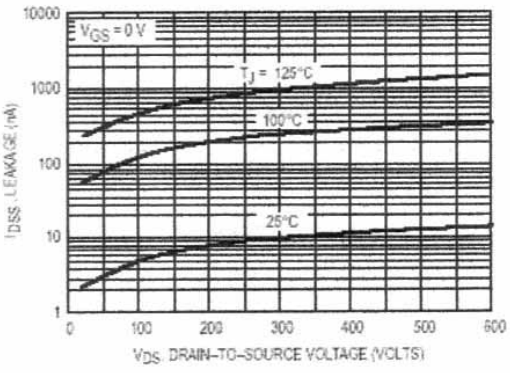


Figure 6. Drain–To–Source Leakage Current versus Voltage

TO-220FP MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.4		4.6	0.173		0.181
B	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
E	0.45		0.7	0.017		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.7	0.045		0.067
F2	1.15		1.7	0.045		0.067
G	4.95		5.2	0.195		0.204
G1	2.4		2.7	0.094		0.106
H	10		10.4	0.393		0.409
L2		16			0.630	
L3	28.6		30.6	1.126		1.204
L4	9.8		10.6	0.385		0.417
L6	15.9		16.4	0.626		0.645
L7	9		9.3	0.354		0.366
Ø	3		3.2	0.118		0.126